

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: ARIYASU, Hideyuki et al Conf.:
Appl. No.: NEW Group:
Filed: February 2, 2001 Examiner:
For: THERMOPLASTIC RESIN INTEGRATED STRUCTURE

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, DC 20231

February 2, 2001

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

IN THE SPECIFICATION:

Please amend the specification as follows:

Page 65: Example 8:

Line 3, change "71.4 wt%" to --62.5 wt%--

Page 73: Line 22, change "72.2" to --135.7--

Line 23, change "55.0" to --65.0--

Page 74: Line 1, change "135.7" to --72.2--

Line 2, change "65.0" to --55.0--

REMARKS

The specification has been amended in order to place the application into better form prior to examination.


Entry of the above amendments is earnestly solicited. An early and favorable first action on the merits is earnestly solicited.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees,

Respectfully submitted,

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By

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